



## Product Change Notification - KSRA-13XFVS583

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**Date:**

26 Jun 2018

**Product Category:**

Ethernet Switches

**Affected CPNs:****Notification subject:**

CCB 3413 Initial Notice: Qualification of ASE as a new assembly site for selected Micrel products available in 64L LQFP (10X10X1.4 mm) package.

**Notification text:****PCN Status:**

Initial notification.

**PCN Type:**

Manufacturing Change

**Microchip Parts Affected:**

Please open one of the icons found in the Affected CPNs section above.

NOTE: For your convenience Microchip includes identical files in two formats (.pdf and .xls).

**Description of Change:**

Qualification of ASE as a new assembly site for selected Micrel products available in 64L LQFP (10X10X1.4 mm) package.

**Pre Change:**

Assembled at Taiwan IC Packing Corp (TICP) using EN4900 die attach and CEL-9200 mold compound material

**Post Change:**

Assembled at ASE INC. (ASE) using CRM-1076WA die attach and EME-G631 mold compound material

**Pre and Post Change Summary:**

	Pre Change	Post Change
Assembly Site	Taiwan IC Packing Corp. (TICP)	ASE Inc. (ASE)
Wire material	EN4900	CRM-1076WA
Die attach material	Au	Au
Molding compound material	CEL-9200	EME-G631
Lead frame material	C7025	C7025

**Impacts to Data Sheet:**

None

**Change Impact:**

None

**Reason for Change:**

To improve manufacturability and on-time delivery performance by qualifying ASE as a new assembly

**Change Implementation Status:**

In Progress

**Estimated Qualification Completion Date:**

November 2018



Note: Please be advised the qualification completion times may be extended because of unforeseen business conditions however implementation will not occur until after qualification has completed and a final PCN has been issued. The final PCN will include the qualification report and estimated first ship date. Also note that after the estimated first ship date guided in the final PCN customers may receive pre and post change parts.

**Time Table Summary:**

Workweek	June 2018					-->	November 2018				
	22	23	24	25	26		44	45	46	47	48
Initial PCN Issue Date				X							
Qual Report Availability										X	
Final PCN Issue Date										X	

**Method to Identify Change:**

Traceability code

**Qualification Plan:**

Please open the attachments included with this PCN labeled as PCN\_#\_Qual\_Plan.

**Revision History:**

**June 26, 2018:** Issued initial notification.

The change described in this PCN does not alter Microchip's current regulatory compliance regarding the material content of the applicable products.

**Attachment(s):**

[PCN\\_KSRA-13XFVS583\\_Qual\\_Plan.pdf](#)

Please contact your local [Microchip sales office](#) with questions or concerns regarding this notification.

**Terms and Conditions:**

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To opt out of future offer or information emails (other than product change notification emails), click here to go to [microchipDIRECT](#) and login, then click on the "My account" link, click on "Update profile" and un-check the box that states "Future offers or information about Microchip's products or services."

Affected Catalog Part Numbers (CPN)

KSZ8873FLL

KSZ8873FLLI

KSZ8873MLL

KSZ8873MLL-AM

KSZ8873MLL-AM-TR

KSZ8873MLLI

KSZ8873MLLJ

KSZ8873MML

KSZ8873MMLI

KSZ8873RLL

KSZ8873RLLI

KSZ8873RLLI-TR

KSZ8873RLLU